

**DECLARATION AND POWER OF ATTORNEY**

As a below named inventor, I hereby declare that:

My residence, Post Office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor of the subject matter which is claimed and for which a patent is sought on the invention, design or discovery entitled:

**"SYSTEM AND METHOD FOR USING A PRE-FORMED FILM IN  
A TRANSFER MOLDING PROCESS FOR AN INTEGRATED CIRCUIT"**

the specification of which is attached hereto and/or was filed in the U.S. Patent Office on \_\_\_\_\_ as U.S. Application No. \_\_\_\_\_.

I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment identified above.

I acknowledge the duty to disclose to the U.S. Patent Office all information known to me to be material to the patentability of this application as defined by Title 37, Code of Federal Regulations, § 1.56.

I claim no priority benefits under 35 U.S.C. § 119 of any foreign or provisional application(s) for patent or inventor's certificate.

I claim no benefit under 35 U.S.C. § 120 of any United States application.

I hereby appoint:

Theodore E. Galanthay, Registration No. 24,122  
Lisa K. Jorgenson, Registration No. 34,845  
Robert D. McCutcheon, Registration No. 38,717  
Mario J. Donato, Jr., Registration No. 37,816  
Nainesh P. Shah, Registration No. 40,166

of STMICROELECTRONICS, INC., and

William A. Munck, Registration No. 39,308  
John T. Mockler, Registration No. 39,775  
Robert A. Kelly, Registration No. 33,922  
Daniel E. Venglarik, Registration No. 39,409

of the firm of NOVAKOV, DAVIS & MUNCK, P.C. as my attorneys with full power of substitution and revocation to prosecute this application and to transact all business in the United States Patent and Trademark Office connected therewith, and to file and prosecute

any international patent applications filed thereon before any international authorities under the Patent Cooperation Treaty.

Send correspondence to:

Lisa K. Jorgenson  
STMICROELECTRONICS, INC.  
1310 Electronics Drive  
Carrollton, Texas 75006

Direct telephone calls to:

Lisa K. Jorgenson  
(972) 466-6000

Atty. Docket No.:

01-C-084

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under § 1001 of Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Full name of first inventor:

Harry Michael Siegel

Inventor's signature:

*Harry Michael Siegel*

Date:

*Jan 30, 2002*

Residence (City, County, State):

Hurst, Tarrant County, Texas

Citizenship:

United States of America

Post Office address:

825 Wheelwood Drive  
Hurst, Texas 76053

Full name of second inventor:

Anthony M. Chiu

Inventor's signature:

Anthony M. Chiu

Date:

Jan 30, 2002

Residence (City, County, State):

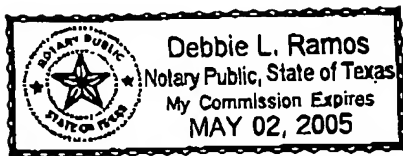
Richardson, Collin County, Texas

Citizenship:

United States of America

Post Office address:

2563 Buttercup Drive  
Richardson, Texas 75082



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